

## VERSIONS WITH MARKING TO SHOW CHANGES MADE

### In the Claims

1. A sublamination material, comprising:  
a conductive single layer reference plane having a top surface and a bottom surface;  
a conductive first signal layer coupled to the top surface with a cured core material, the  
first signal layer having an exposed surface opposite a surface coupled to the  
reference plane;  
a conductive second signal layer coupled to the bottom surface with a cured bond-ply  
material, the second signal layer having an exposed surface opposite a surface  
coupled to the reference plane; and  
at least one of a blind via or a micro via; wherein  
the reference plane, first signal layer, and second signal layer are three separate layers.